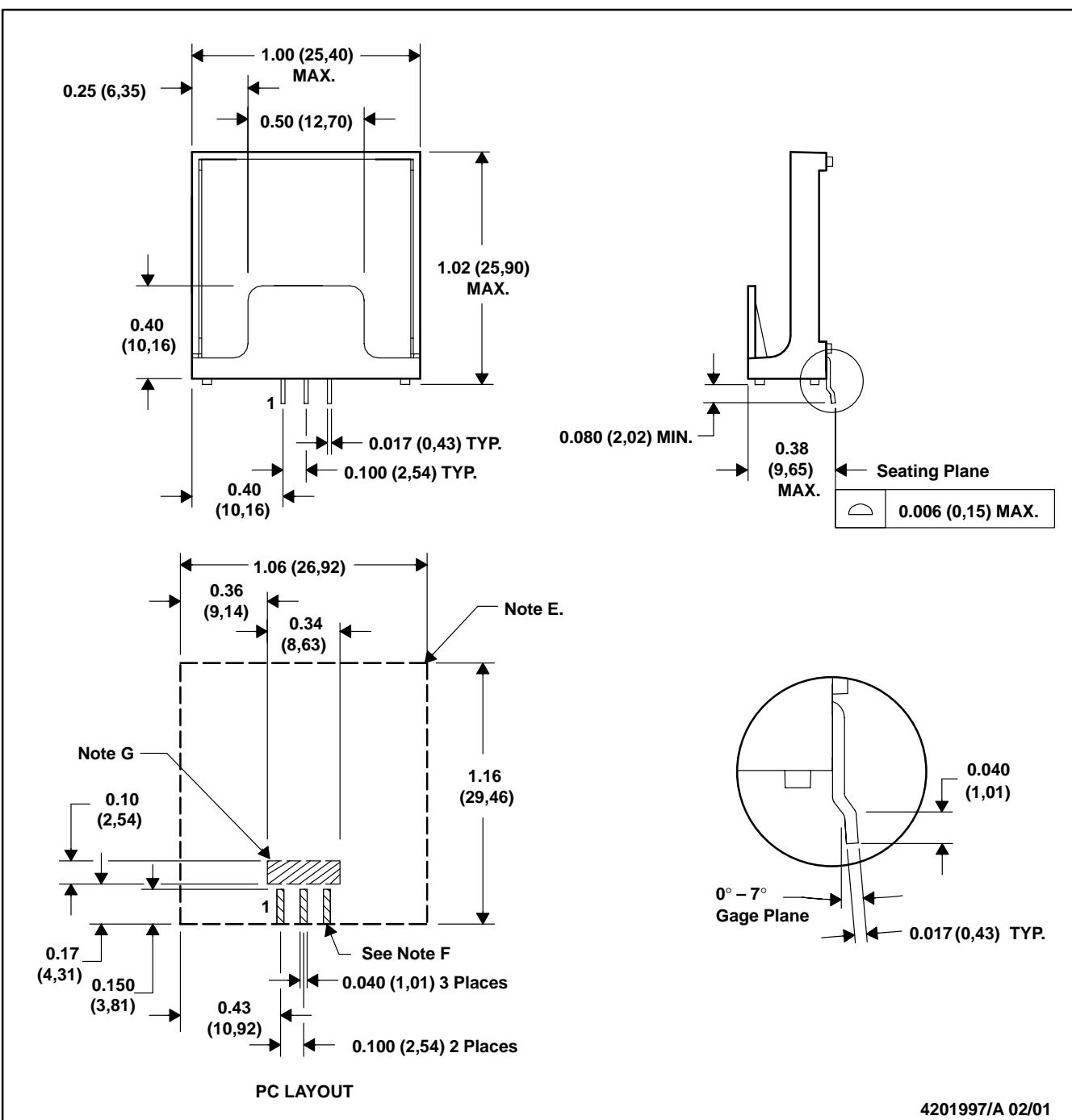


EAC (R-PSIP-G3)

PLASTIC SINGLE-IN-LINE MODULE



NOTES:

- All linear dimensions are in inches (mm).
- This drawing is subject to change without notice.
- 2-place decimals are ± 0.030 (± 0.76 mm).
- 3-place decimals are ± 0.010 (± 0.25 mm).
- Recommended mechanical keep-out area.
- Power pin connections should utilize two or more vias per input, ground and output pin.
- No copper, power or signal traces in this area.

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